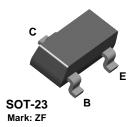


# 2N4126

# **MMBT4126**





# **PNP General Purpose Amplifier**

This device is designed for general purpose amplifier and switching applications at collector currents to 10 µA as a switch and to 100 mA as an amplifier.

#### **Absolute Maximum Ratings\*** TA = 25°C unless otherwise noted

| Symbol                            | Parameter  | Value       | Units |  |
|-----------------------------------|--|-------------|-------|--|
| V <sub>CEO</sub>                  | Collector-Emitter Voltage                        | 25          | V     |  |
| V <sub>CBO</sub>                  | Collector-Base Voltage                           | 25          | V     |  |
| V <sub>EBO</sub>                  | Emitter-Base Voltage                             | 4.0         | V     |  |
| I <sub>C</sub>                    | Collector Current - Continuous                   | 200         | mA    |  |
| T <sub>J</sub> , T <sub>stg</sub> | Operating and Storage Junction Temperature Range | -55 to +150 | °C    |  |

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.

  2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- 3) All voltages (V) and currents (A) are negative polarity for PNP transistors.

#### **Thermal Characteristics** TA= 25°C unless otherwise noted

| Symbol          | Characteristic                          | Max    |           | Units |
|-----------------|---|--------|-----------|-------|
|                 |   | 2N4126 | *MMBT4126 |       |
| $P_D$           | Total Device Dissipation                | 625    | 350       | mW    |
|                 | Derate above 25°C                       | 5.0    | 2.8       | mW/°C |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case    | 83.3   |           | °C/W  |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 200    | 357       | °C/W  |

<sup>\*</sup>Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

# PNP General Purpose Amplifier (continued)

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|---------------|-----------|------------|
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| 1 150.1110.01 | Callal at |            |

TA = 25°C unless otherwise noted

| Parameter                           | Test Conditions   | Min | Max  | Units  |
|-------------------------------------|---|-----|--|--|
|                                     |   |     |  |  |
| RACTERISTICS                        |   |     |  |  |
| Collector-Emitter Breakdown Voltage | $I_C = 1.0 \text{ mA}, I_B = 0$   | 25  |  | V  |
| Collector-Base Breakdown Voltage    | $I_C = 10 \mu\text{A},  I_E = 0$  | 25  |  | V  |
| Emitter-Base Breakdown Voltage      | $I_C = 10 \mu\text{A},  I_C = 0$  | 4.0 |  | V  |
| Collector Cutoff Current            | $V_{CB} = 20 \text{ V}, I_{E} = 0$  |     | 50   | nA   |
| Emitter Cutoff Current              | $V_{EB} = 3.0 \text{ V}, I_{C} = 0$   |     | 50   | nA   |
|                                     | RACTERISTICS  Collector-Emitter Breakdown Voltage  Collector-Base Breakdown Voltage  Emitter-Base Breakdown Voltage  Collector Cutoff Current |     | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ |

### ON CHARACTERISTICS\*

| h <sub>FE</sub>      | DC Current Gain                      | $I_C = 2.0 \text{ mA}, V_{CE} = 1.0 \text{ V}$ | 120 | 360  |   |
|----------------------|--------------------------------------|--|-----|------|---|
|                      |                                      | $I_C = 50 \text{ mA}, V_{CE} = 1.0 \text{ V}$  | 60  |      |   |
| V <sub>CE(sat)</sub> | Collector-Emitter Saturation Voltage | $I_C = 50 \text{ mA}, I_B = 5.0 \text{ mA}$    |     | 0.4  | V |
| V <sub>BE(sat)</sub> | Base-Emitter Saturation Voltage      | $I_C = 50 \text{ mA}, I_B = 5.0 \text{ mA}$    |     | 0.95 | V |

### SMALL SIGNAL CHARACTERISTICS

| f <sub>T</sub>   | Current Gain - Bandwidth Product | $I_C = 10 \text{ mA}, V_{CE} = 20 \text{ V},$<br>f = 100  MHz               | 250 |     | MHz |
|------------------|----------------------------------|---|-----|-----|-----|
| C <sub>ibo</sub> | Input Capacitance                | $V_{EB} = 0.5 \text{ V}, I_{C} = 0,$<br>f = 1.0  MHz                        |     | 10  | pF  |
| C <sub>cb</sub>  | Collector-Base Capcitance        | $V_{CB} = 5.0 \text{ V}, I_{E} = 0,$<br>f = 100 kHz                         |     | 4.5 | pF  |
| h <sub>fe</sub>  | Small-Signal Current Gain        | $I_C = 2.0 \text{ mA}, V_{CE} = 10 \text{ V},$<br>f = 1.0  kHz              | 120 | 480 |     |
| NF               | Noise Figure                     | $I_C = 100 \mu A$ , $V_{CE} = 5.0 V$ , $R_S=1.0 kΩ$ , $f=10 Hz$ to 15.7 kHz |     | 4.0 | dB  |

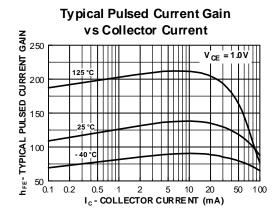
<sup>\*</sup>Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%

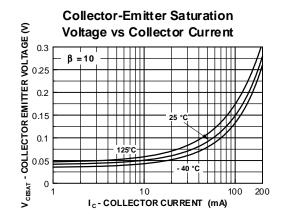
**NOTE:** All voltages (V) and currents (A) are negative polarity for PNP transistors.

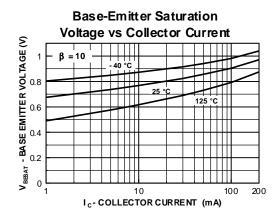
## **PNP General Purpose Amplifier**

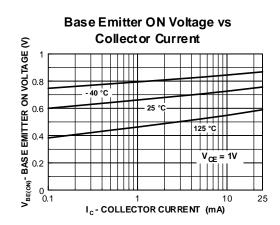
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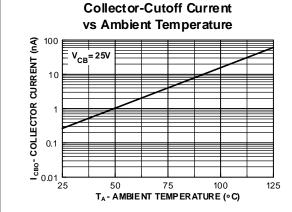
## **Typical Characteristics**

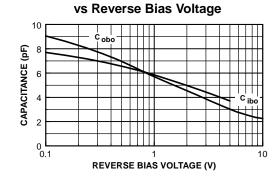












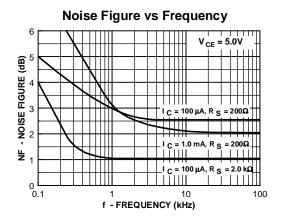
**Common-Base Open Circuit** 

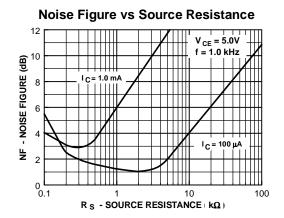
**Input and Output Capacitance** 

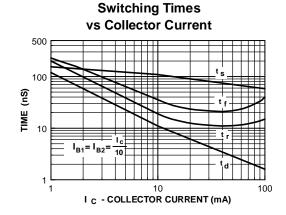
# **PNP General Purpose Amplifier**

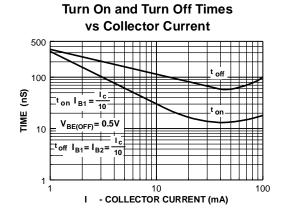
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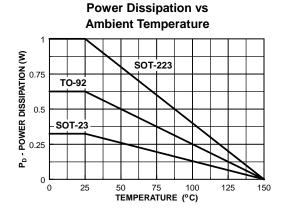
## Typical Characteristics (continued)







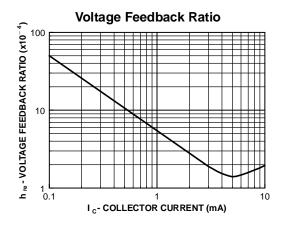


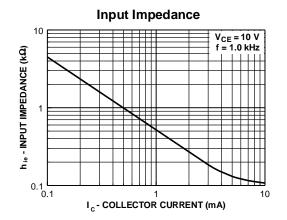


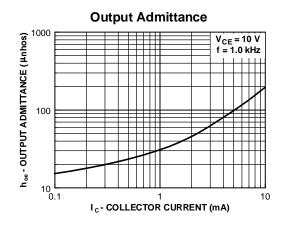
# **PNP General Purpose Amplifier**

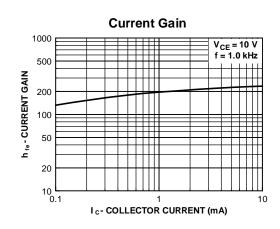
(continued)

# Typical Characteristics (continued)









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|--------------------------|---------------------------|---|
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